



SBC-241PL16-31x-S271

鍍層厚度:

|             |
|-------------|
| Blank : 1u" |
| 2 : 15u"    |
| 3 : 30u"    |

**SPECIFICATIONS**

**Electrical:**

1. Rating: 3.0A
2. Contact Resistance: 40 mΩ Max
3. Insulation Resistance: 100 MΩ Min
4. Dielectric Withstanding Voltage: 100V AC

**Material:**

1. Housing: LCP, UL 94V-0
2. Contact: Copper Alloy
3. Shell: SUS

**Finish:**

1. Contact: Plated Gold in Mating Area ;  
Tin Plated on Solder Balls ;  
Nickel under plated overall
2. Shell: Nickel under Plated surface layer

前端接口

**CONTACT** 建倚科技股份有限公司  
**CONTACT TECHNOLOGY CORP.**

TOLERANCE UNLESS OTHERWISE STATED :  
Up to 5 ±0.2  
Above 5 ~ 15 ±0.3  
Above 15 ~ 30 ±0.4  
Above 30 ~ 50 ±0.5  
Angle ±0.3°

3RD. ANGEL'S

UNITS MM

|                        |                |           |        |          |  |
|------------------------|----------------|-----------|--------|----------|--|
| DRAWN BY: Jack Lu      | DATE: 04/05/17 | MAT'L     |        | TITLE    | CONNECTOR                                |
| CHECKED BY: Jacky Chen | DATE: 04/05/17 | FINISH    |        | MODLE    | USB 3.1 TYPE C 公頭拉伸帶板<br>帶帶電容10nF L11.10 |
| APPROVED BY: Tony Kao  | DATE: 04/05/17 | SCALE     | 1 : 1  | DWG NO.  | SBC-241PL16-31x-S271                     |
|                        |                | SHEET NO. | 1 of 1 | PART NO. | SBC-241PL16-31x-S271                     |
|                        |                |           |        | SIZE     | A4                                       |
|                        |                |           |        | VER      | R  |